

TOSHIBA CMOS Digital Integrated Circuit Silicon Monolithic

TC74LCX273F, TC74LCX273FK

Low-Voltage Octal D-Type Flip-Flop with Clear with 5-V Tolerant Inputs and Outputs

The TC74LCX273 is a high-performance CMOS octal D-type flip-flop. Designed for use in 3.3-V systems, it achieves high-speed operation while maintaining the CMOS low-power dissipation.

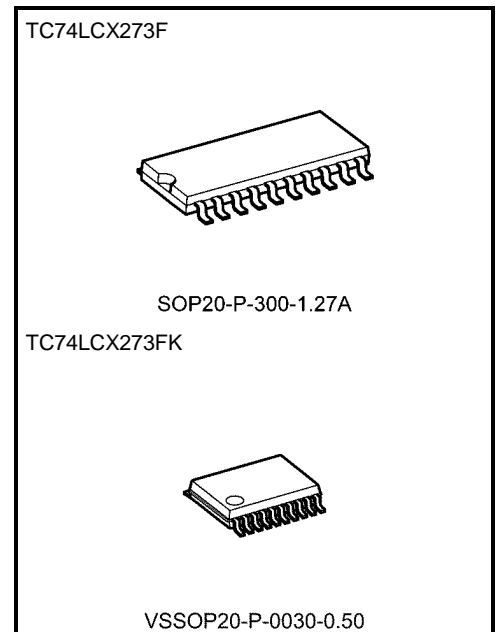
The device is designed for low-voltage (3.3 V) VCC applications, but it could be used to interface to 5-V supply environment for both inputs and outputs.

This 8 bit D-type flip-flop is controlled by a clock input (CK) and a clear input ($\overline{\text{CLR}}$). When the $\overline{\text{CLR}}$ input is low, the eight outputs are at a low logic level.

All inputs are equipped with protection circuits against static discharge.

Features

- Low-voltage operation: VCC = 1.65 to 3.6 V
- High-speed operation: tpd = 8.5 ns (max) (VCC = 3.0 to 3.6 V)
- Output current: |IOH|/IOL = 24 mA (min) (VCC = 3.0 V)
- Available in JEITA SOP, VSSOP (US)
- Power-down protection is provided on all inputs and outputs
- Pin and function compatible with the 74 series
(74AC/VHC/HC/F/ALS/LS etc.) 273 type

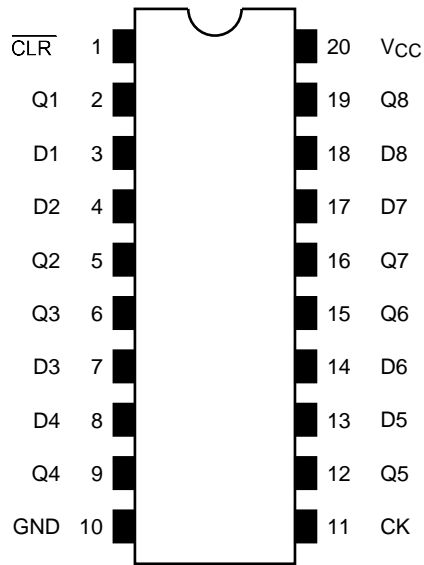


Weight	
SOP20-P-300-1.27A	: 0.22 g (typ.)
VSSOP20-P-0030-0.50	: 0.03 g (typ.)

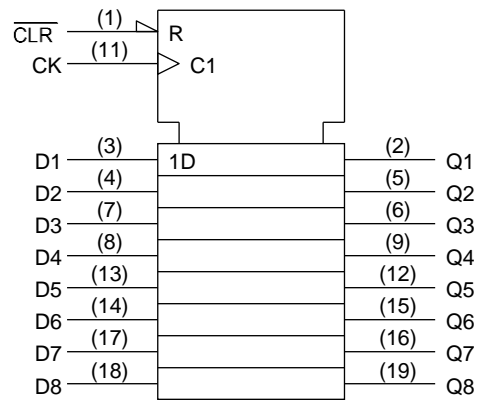
Note: The Electrical Characteristics of VCC = 1.8 ± 0.15 V is only applicable for products which manufactured from January 2009 onward.

Start of commercial production
2000-02

Pin Assignment (top view)



IEC Logic Symbol

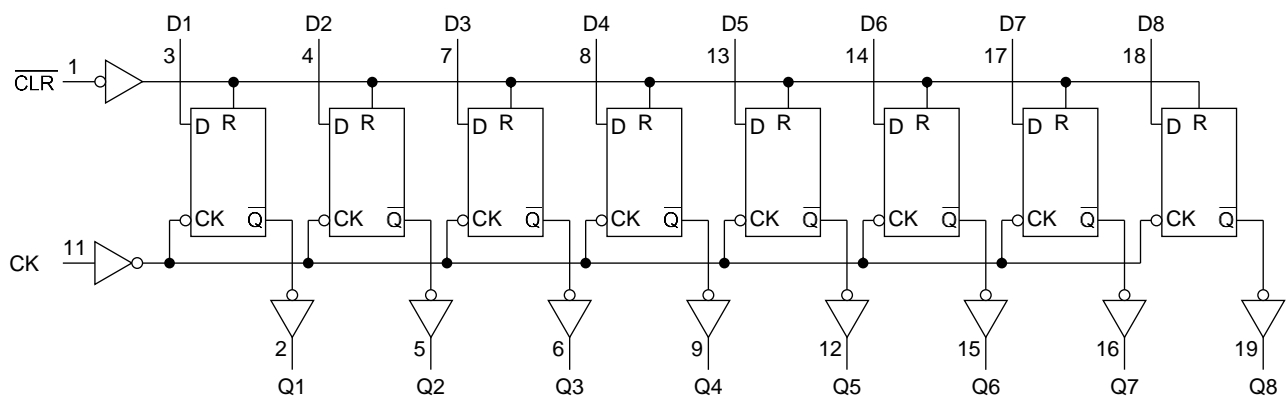


Truth Table

Inputs			Outputs	Function
$\overline{\text{CLR}}$	D	CK	Q	
L	X	X	L	Clear
H	L	\uparrow	L	—
H	H	\uparrow	H	—
H	X	\downarrow	Qn	No change

X: Don't care

System Diagram



Absolute Maximum Ratings (Note 1)

Characteristics	Symbol	Rating	Unit
Power supply voltage	V _{CC}	-0.5 to 7.0	V
DC input voltage	V _{IN}	-0.5 to 7.0	V
DC output voltage	V _{OUT}	-0.5 to 7.0 (Note 2)	V
		-0.5 to V _{CC} + 0.5 (Note 3)	
Input diode current	I _{IK}	-50	mA
Output diode current	I _{OK}	±50 (Note 4)	mA
DC output current	I _{OUT}	±50	mA
Power dissipation	P _D	180	mW
DC V _{CC} /ground current	I _{CC} /I _{GND}	±100	mA
Storage temperature	T _{stg}	-65 to 150	°C

Note 1: Exceeding any of the absolute maximum ratings, even briefly, lead to deterioration in IC performance or even destruction.

Using continuously under heavy loads (e.g. the application of high temperature/current/voltage and the significant change in temperature, etc.) may cause this product to decrease in the reliability significantly even if the operating conditions (i.e. operating temperature/current/voltage, etc.) are within the absolute maximum ratings and the operating ranges.

Please design the appropriate reliability upon reviewing the Toshiba Semiconductor Reliability Handbook ("Handling Precautions"/"Derating Concept and Methods") and individual reliability data (i.e. reliability test report and estimated failure rate, etc).

Note 2: V_{CC} = 0 V

Note 3: High or low state. I_{OUT} absolute maximum rating must be observed.

Note 4: V_{OUT} < GND, V_{OUT} > V_{CC}

Operating Ranges (Note 1)

Characteristics	Symbol	Rating	Unit
Power supply voltage	V _{CC}	1.65 to 3.6	V
		1.5 to 3.6 (Note 2)	
Input voltage	V _{IN}	0 to 5.5	V
Output voltage	V _{OUT}	0 to 5.5 (Note 3)	V
		0 to V _{CC} (Note 4)	
Output current	I _{OH} /I _{OL}	±24 (Note 5)	mA
		±12 (Note 6)	
Operating temperature	T _{opr}	-40 to 85	°C
Input rise and fall time	dt/dv	0 to 10 (Note 7)	ns/V

Note 1: The operating ranges must be maintained to ensure the normal operation of the device. Unused inputs must be tied to either V_{CC} or GND.

Note 2: Data retention only

Note 3: V_{CC} = 0 V

Note 4: High or low state

Note 5: V_{CC} = 3.0 to 3.6 V

Note 6: V_{CC} = 2.7 to 3.0 V

Note 7: V_{IN} = 0.8 to 2.0 V, V_{CC} = 3.0 V

Electrical Characteristics

DC Characteristics (Ta = -40 to 85°C)

Characteristics		Symbol	Test Condition	V _{CC} (V)	Min	Max	Unit	
Input voltage	H-level	V _{IH}		1.65 to 2.3	V _{CC} × 0.9	—	V	
				2.3 to 2.7	1.7	—		
				2.7 to 3.6	2.0	—		
	L-level	V _{IL}		1.65 to 2.3	—	V _{CC} × 0.1		
				2.3 to 2.7	—	0.7		
				2.7 to 3.6	—	0.8		
Output voltage	H-level	V _{OH}	V _{IN} = V _{IH} or V _{IL}	I _{OH} = -100 μA	1.65 to 3.6	V _{CC} - 0.2	V	
				I _{OH} = -4 mA	1.65	1.05		—
				I _{OH} = -8 mA	2.3	1.7		—
				I _{OH} = -12 mA	2.7	2.2		—
				I _{OH} = -18 mA	3.0	2.4		—
				I _{OH} = -24 mA	3.0	2.2		—
	L-level	V _{OL}		I _{OL} = 100 μA	1.65 to 3.6	—		0.2
				I _{OL} = 4 mA	1.65	—		0.45
				I _{OL} = 8 mA	2.3	—		0.7
				I _{OL} = 12 mA	2.7	—		0.4
				I _{OL} = 16 mA	3.0	—		0.4
				I _{OL} = 24 mA	3.0	—		0.55
Input leakage current		I _{IN}	V _{IN} = 0 to 5.5 V	1.65 to 3.6	—	±5.0	μA	
Power-off leakage current		I _{OFF}	V _{IN} /V _{OUT} = 5.5 V	0	—	10.0	μA	
Quiescent supply current		I _{CC}	V _{IN} = V _{CC} or GND	1.65 to 3.6	—	10.0	μA	
			V _{IN} = 3.6 to 5.5 V	1.65 to 3.6	—	±10.0		
Increase in I _{CC} per input		ΔI _{CC}	V _{IN} = V _{CC} - 0.6 V (per 1 input)	2.7 to 3.6	—	500		

AC Characteristics (Ta = -40 to 85°C)

Characteristics	Symbol	Test Condition	V _{CC} (V)	Min	Max	Unit
Maximum clock frequency	f _{MAX}	(Figure 1, Figure 2)	1.8 ± 0.15	50	—	MHz
			2.5 ± 0.2	100	—	
			2.7	150	—	
			3.3 ± 0.3	150	—	
Propagation delay time (CK-Q)	t _{PLH} t _{PHL}	(Figure 1, Figure 2)	1.8 ± 0.15	—	30.0	ns
			2.5 ± 0.2	—	10.5	
			2.7	—	9.5	
			3.3 ± 0.3	1.5	8.5	
Propagation delay time ($\overline{\text{CLR}}$ -Q)	t _{PHL}	(Figure 1, Figure 3)	1.8 ± 0.15	—	30.0	ns
			2.5 ± 0.2	—	10.5	
			2.7	—	9.5	
			3.3 ± 0.3	1.5	8.5	
Minimum pulse width (CK)	t _w (H) t _w (L)	(Figure 1, Figure 2)	1.8 ± 0.15	10.0	—	ns
			2.5 ± 0.2	5.0	—	
			2.7	3.3	—	
			3.3 ± 0.3	3.3	—	
Minimum pulse width ($\overline{\text{CLR}}$)	t _w (L)	(Figure 3)	1.8 ± 0.15	10.0	—	ns
			2.5 ± 0.2	5.0	—	
			2.7	3.3	—	
			3.3 ± 0.3	3.3	—	
Minimum setup time	t _s	(Figure 1, Figure 2)	1.8 ± 0.15	10.0	—	ns
			2.5 ± 0.2	5.0	—	
			2.7	2.5	—	
			3.3 ± 0.3	2.5	—	
Minimum hold time	t _h	(Figure 1, Figure 2)	1.8 ± 0.15	1.5	—	ns
			2.5 ± 0.2	1.5	—	
			2.7	1.5	—	
			3.3 ± 0.3	1.5	—	
Minimum removal time	t _{rem}	(Figure 4)	1.8 ± 0.15	8.0	—	ns
			2.5 ± 0.2	4.0	—	
			2.7	2.5	—	
			3.3 ± 0.3	2.0	—	
Output to output skew	t _{osLH} t _{osHL}	(Note)	2.7	—	—	ns
			3.3 ± 0.3	—	1.0	

Note: Parameter guaranteed by design.
 (t_{osLH} = |t_{PLHm} - t_{PLHn}|, t_{osHL} = |t_{PHLm} - t_{PHLn}|)

Dynamic Switching Characteristics

($T_a = 25^\circ\text{C}$, input: $t_r = t_f = 2.5 \text{ ns}$, $C_L = 50 \text{ pF}$, $R_L = 500 \Omega$)

Characteristics	Symbol	Test Condition	VCC (V)	Typ.	Unit
			3.3		
Quiet output maximum dynamic V_{OL}	V_{OLP}	$V_{IH} = 3.3 \text{ V}$, $V_{IL} = 0 \text{ V}$	3.3	0.8	V
Quiet output minimum dynamic V_{OL}	$ V_{OLV} $	$V_{IH} = 3.3 \text{ V}$, $V_{IL} = 0 \text{ V}$	3.3	0.8	V

Capacitive Characteristics ($T_a = 25^\circ\text{C}$)

Characteristics	Symbol	Test Condition	VCC (V)	Typ.	Unit
			3.3		
Input capacitance	C_{IN}	—	3.3	7	pF
Output capacitance	C_{OUT}	—	0	8	pF
Power dissipation capacitance	CPD	$f_{IN} = 10 \text{ MHz}$ (Note)	3.3	25	pF

Note: CPD is defined as the value of the internal equivalent capacitance which is calculated from the operating current consumption.

Average operating current can be obtained by the equation:

$$I_{CC}(\text{opr}) = CPD \cdot V_{CC} \cdot f_{IN} + I_{CC}/8 \text{ (per bit)}$$

AC Test Circuit

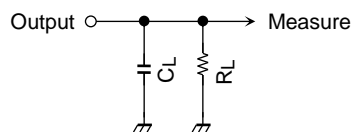


Figure 1

AC Waveform

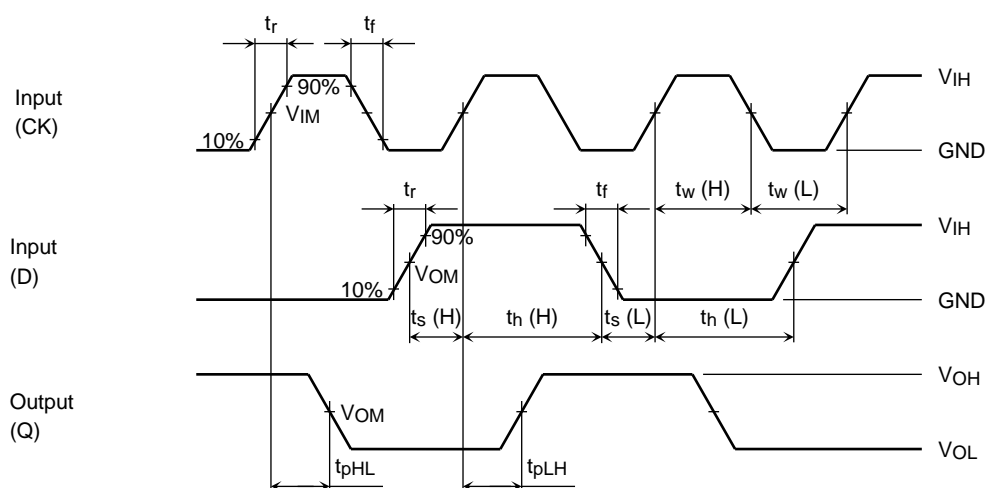


Figure 2 t_{pLH} , t_{pHL} , t_w , t_s , t_h

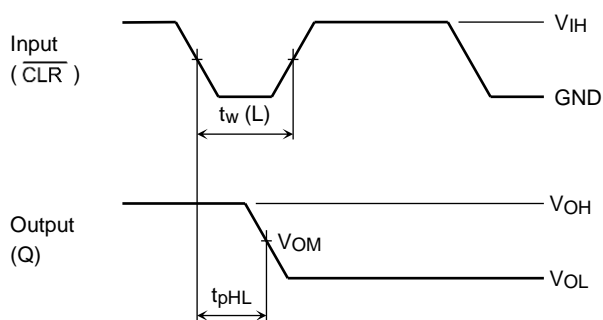


Figure 3 t_{pHL}

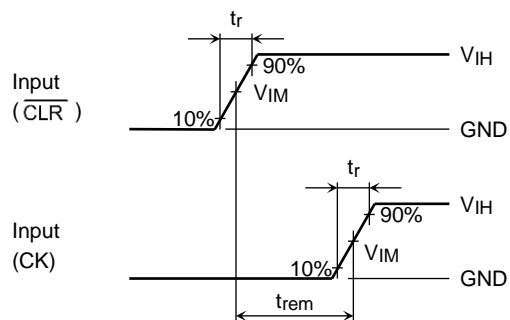


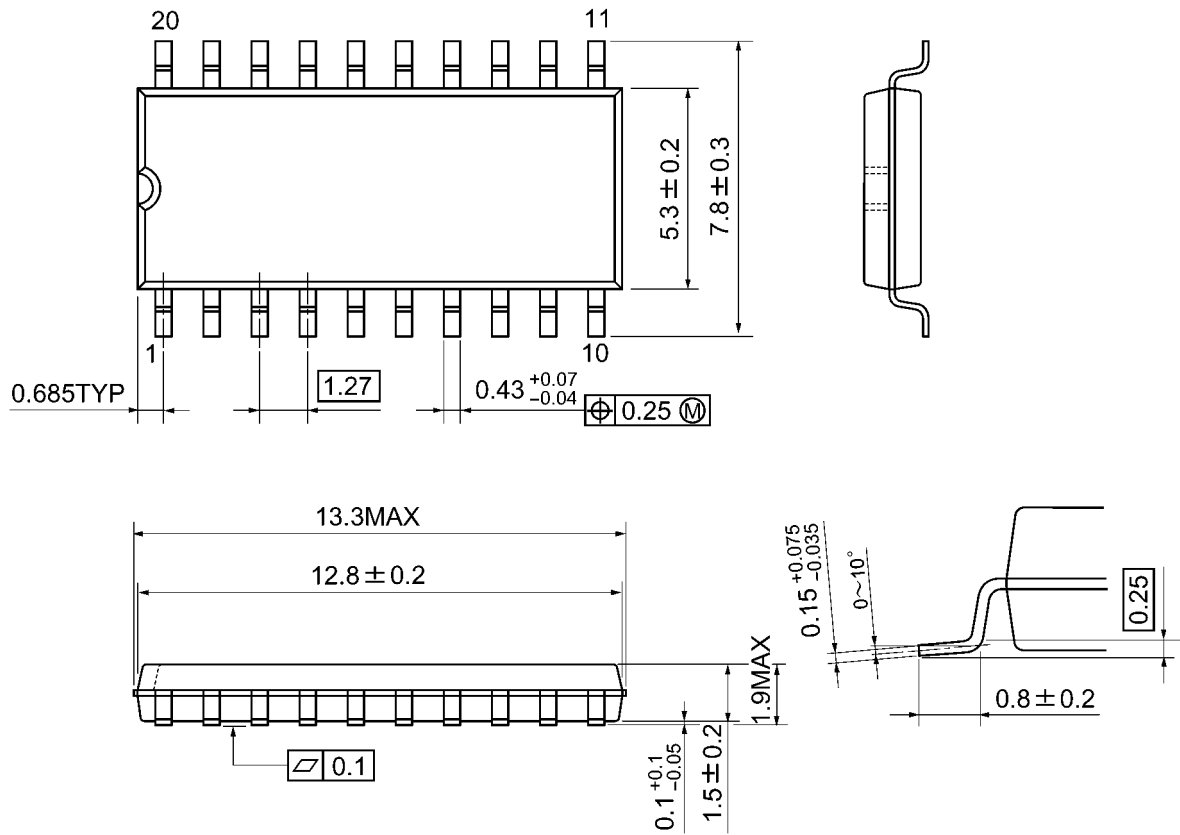
Figure 4 t_{rem}

	Symbol	V _{CC}		
		3.3 ± 0.3 V 2.7 V	2.5 ± 0.2 V	1.8 ± 0.15 V
Input	V _{IH}	2.7 V	V _{CC}	V _{CC}
	V _{IM}	1.5 V	V _{CC} /2	V _{CC} /2
	t _r , t _f	2.5 ns	2.0 ns	2.0 ns
Output	V _{OM}	1.5 V	V _{OH} /2	V _{OH} /2
Load	C _L	50 pF	30 pF	30 pF
	R _L	500 Ω	500 Ω	1 kΩ

Package Dimensions

SOP20-P-300-1.27A

Unit: mm

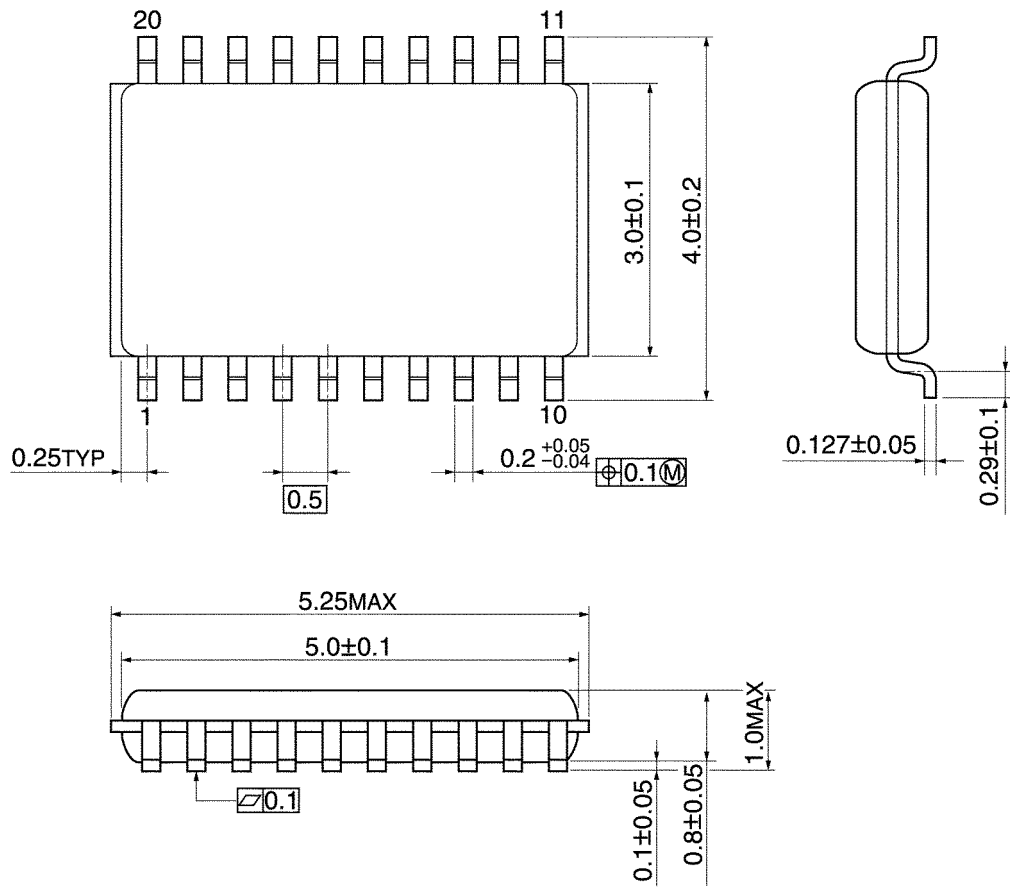


Weight: 0.22 g (typ.)

Package Dimensions

VSSOP20-P-0030-0.50

Unit: mm



Weight: 0.03 g (typ.)

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